

Accepted Manuscript

An advanced underplatform damper modelling approach based on a microslip contact model

L. Pesaresi, J. Armand, C.W. Schwingshackl, L. Salles, C. Wong



PII: S0022-460X(18)30520-0

DOI: [10.1016/j.jsv.2018.08.014](https://doi.org/10.1016/j.jsv.2018.08.014)

Reference: YJSVI 14305

To appear in: *Journal of Sound and Vibration*

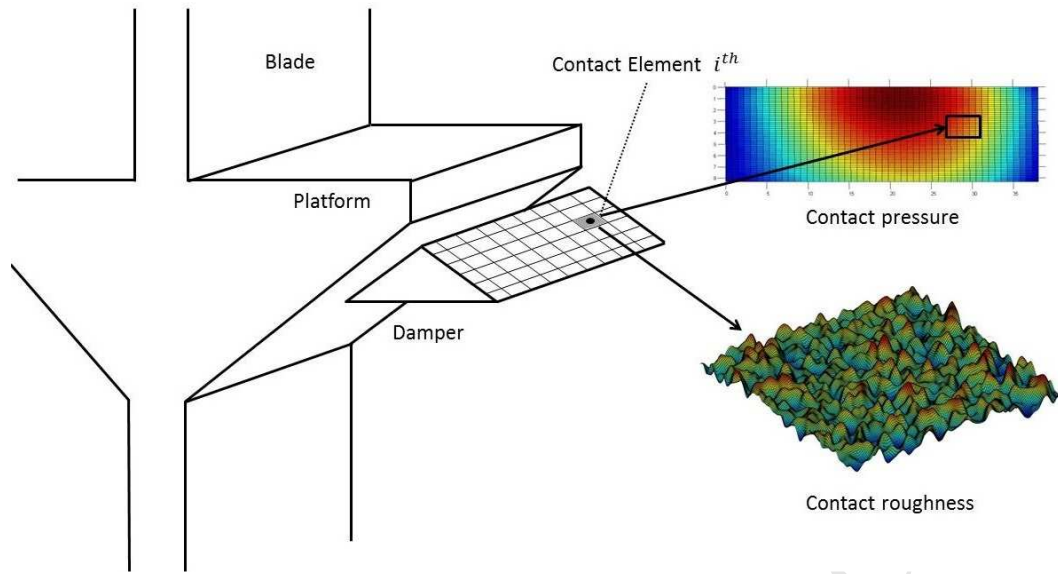
Received Date: 18 April 2018

Revised Date: 27 July 2018

Accepted Date: 10 August 2018

Please cite this article as: L. Pesaresi, J. Armand, C.W. Schwingshackl, L. Salles, C. Wong, An advanced underplatform damper modelling approach based on a microslip contact model, *Journal of Sound and Vibration* (2018), doi: 10.1016/j.jsv.2018.08.014.

This is a PDF file of an unedited manuscript that has been accepted for publication. As a service to our customers we are providing this early version of the manuscript. The manuscript will undergo copyediting, typesetting, and review of the resulting proof before it is published in its final form. Please note that during the production process errors may be discovered which could affect the content, and all legal disclaimers that apply to the journal pertain.



ACCEPTED MANUSCRIPT

Download English Version:

<https://daneshyari.com/en/article/11028172>

Download Persian Version:

<https://daneshyari.com/article/11028172>

[Daneshyari.com](https://daneshyari.com)